

#### UPDATED: 05/08/2008

# EMP114-P1

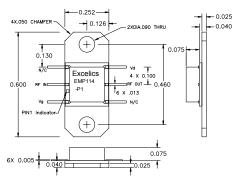
# 7.0 – 9.0 GHz Power Amplifier MMIC

## FEATURES

- 7.0 9.0 GHz Operating Frequency Range
- 30.0dBm Output Power at 1dB Compression
- 18.0 dB Typical Small Signal Gain
- -40dBc OIMD3 @Each Tone Pout 20dBm

## **APPLICATIONS**

- Point-to-point and point-to-multipoint radio
- Military Radar Systems



Optional Packaging solutions are available Contact the Excelics sales team for details.

## Caution! ESD sensitive device.

## ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C, 50 ohm, VDD= 7 V, IDQ= 800 mA)

SYMBOL	PARAMETER/TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
F	Operating Frequency Range	7.0		9.0	GHz
P1dB	Output Power at 1dB Gain Compression	28.5	30.0		dBm
Gss	Small Signal Gain	16.0	18.0		dB
OIMD3	Output 3 <sup>rd</sup> Order Intermodulation Distortion @∆f=10MHz, Each Tone Pout 20dBm		-40		dBc
Input RL	Input Return Loss		-12		dB
Output RL	Output Return Loss		-6		dB
ldss	Saturate Drain Current $V_{DS} = 3V, V_{GS} = 0V$	992	1240	1488	mA
V <sub>DD</sub>	Power Supply Voltage		7	8	V
Rth	Thermal Resistance (Au-Sn Eutectic Attach)		7.5		°C/W
Tb	Operating Base Plate Temperature	- 35		+ 85	°C

# ABSOLUTE MAXIMUM RATINGS FOR CONTINUOUS OPERATION<sup>1,2</sup>

SYMBOL	CHARACTERISTIC	VALUE	
V <sub>DS</sub>	Drain to Source Voltage	8 V	
$V_{GS}$	Gate to Source Voltage	- 4 V	
I <sub>DD</sub>	Drain Current	ldss	
I <sub>GSF</sub>	Forward Gate Current	18 mA	
P <sub>IN</sub>	Input Power	@ 3dB compression	
Т <sub>сн</sub>	Channel Temperature	150°C	
T <sub>STG</sub>	Storage Temperature	-65/150°C	
P <sub>T</sub>	Total Power Dissipation	15.2W	

1. Operating the device beyond any of the above rating may result in permanent damage.

2. Bias conditions must also satisfy the following equation V<sub>DS</sub>\*I<sub>DS</sub> < (T<sub>CH</sub> -T<sub>HS</sub>)/R<sub>TH</sub>; where T<sub>HS</sub> = ambient temperature



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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.